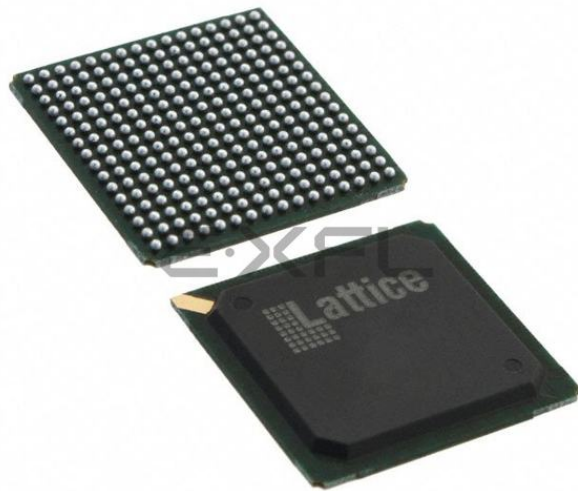




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

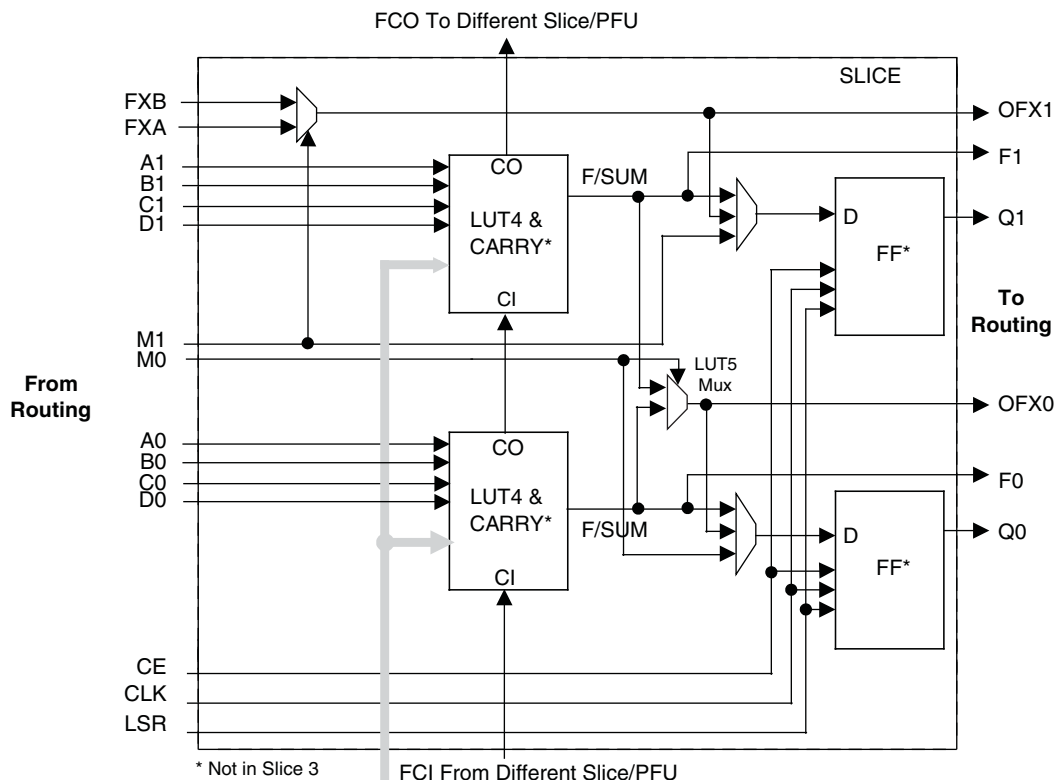
Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	2625
Number of Logic Elements/Cells	21000
Total RAM Bits	282624
Number of I/O	193
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-20se-5f256i

Figure 2-4. Slice Diagram



For Slices 0 and 2, memory control signals are generated from Slice 1 as follows:

WCK is CLK
WRE is from LSR
DI[3:2] for Slice 2 and DI[1:0] for Slice 0 data
WAD [A:D] is a 4bit address from slice 1 LUT input

Table 2-2. Slice Signal Descriptions

Function	Type	Signal Names	Description
Input	Data signal	A0, B0, C0, D0	Inputs to LUT4
Input	Data signal	A1, B1, C1, D1	Inputs to LUT4
Input	Multi-purpose	M0	Multipurpose Input
Input	Multi-purpose	M1	Multipurpose Input
Input	Control signal	CE	Clock Enable
Input	Control signal	LSR	Local Set/Reset
Input	Control signal	CLK	System Clock
Input	Inter-PFU signal	FC	Fast Carry-in ¹
Input	Inter-slice signal	FXA	Intermediate signal to generate LUT6 and LUT7
Input	Inter-slice signal	FXB	Intermediate signal to generate LUT6 and LUT7
Output	Data signals	F0, F1	LUT4 output register bypass signals
Output	Data signals	Q0, Q1	Register outputs
Output	Data signals	OFX0	Output of a LUT5 MUX
Output	Data signals	OFX1	Output of a LUT6, LUT7, LUT8 ² MUX depending on the slice
Output	Inter-PFU signal	FCO	Slice 2 of each PFU is the fast carry chain output ¹

1. See Figure 2-4 for connection details.

2. Requires two PFUs.

Modes of Operation

Each slice has up to four potential modes of operation: Logic, Ripple, RAM and ROM.

Logic Mode

In this mode, the LUTs in each slice are configured as 4-input combinatorial lookup tables. A LUT4 can have 16 possible input combinations. Any four input logic functions can be generated by programming this lookup table. Since there are two LUT4s per slice, a LUT5 can be constructed within one slice. Larger look-up tables such as LUT6, LUT7 and LUT8 can be constructed by concatenating other slices. Note LUT8 requires more than four slices.

Ripple Mode

Ripple mode supports the efficient implementation of small arithmetic functions. In ripple mode, the following functions can be implemented by each slice:

- Addition 2-bit
- Subtraction 2-bit
- Add/Subtract 2-bit using dynamic control
- Up counter 2-bit
- Down counter 2-bit
- Up/Down counter with Async clear
- Up/Down counter with preload (sync)
- Ripple mode multiplier building block
- Multiplier support
- Comparator functions of A and B inputs
 - A greater-than-or-equal-to B
 - A not-equal-to B
 - A less-than-or-equal-to B

Ripple Mode includes an optional configuration that performs arithmetic using fast carry chain methods. In this configuration (also referred to as CCU2 mode) two additional signals, Carry Generate and Carry Propagate, are generated on a per slice basis to allow fast arithmetic functions to be constructed by concatenating Slices.

RAM Mode

In this mode, a 16x4-bit distributed single port RAM (SPR) can be constructed using each LUT block in Slice 0 and Slice 2 as a 16x1-bit memory. Slice 1 is used to provide memory address and control signals. A 16x2-bit pseudo dual port RAM (PDPR) memory is created by using one Slice as the read-write port and the other companion slice as the read-only port.

The Lattice design tools support the creation of a variety of different size memories. Where appropriate, the software will construct these using distributed memory primitives that represent the capabilities of the PFU. Table 2-3 shows the number of slices required to implement different distributed RAM primitives. For more information about using RAM in LatticeECP2/M devices, please see the list of additional technical documentation at the end of this data sheet.

Table 2-3. Number of Slices Required to Implement Distributed RAM

	SPR 16X4	PDPR 16X4
Number of slices	3	3

Note: SPR = Single Port RAM, PDPR = Pseudo Dual Port RAM

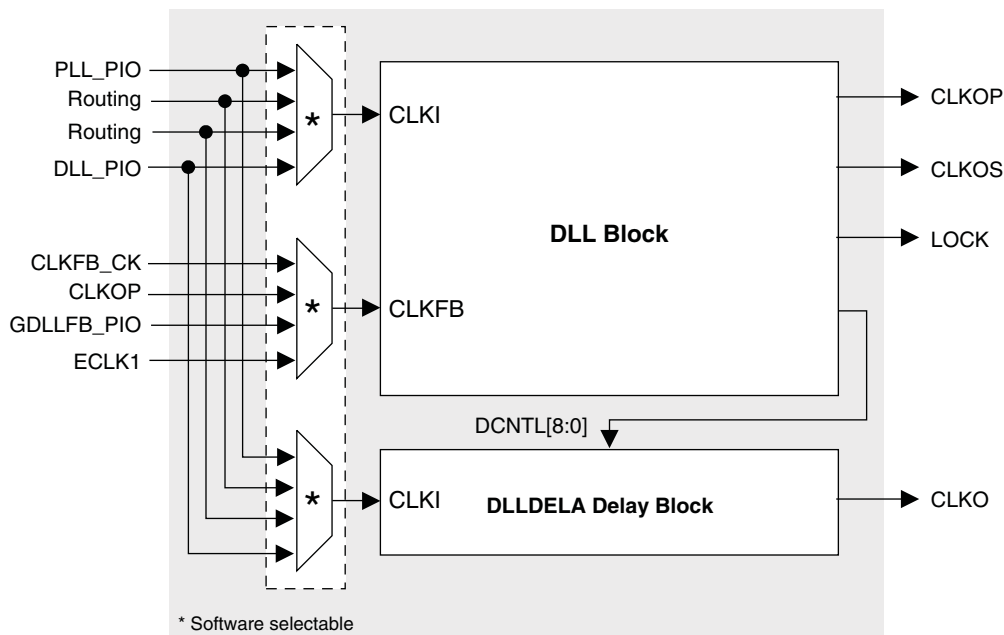
Table 2-5. DLL Signals

Signal	I/O	Description
CLKI	I	Clock input from external pin or routing
CLKFB	I	DLL feed input from DLL output, clock net, routing or external pin
RSTN	I	Active low synchronous reset
ALUHOLD	I	Active high freezes the ALU
UDDCNTL	I	Synchronous enable signal (hold high for two cycles) from routing
DCNTL[8:0]	O	Encoded digital control signals for PIC INDEL and slave delay calibration
CLKOP	O	The primary clock output
CLKOS	O	The secondary clock output with fine phase shift and/or division by 2 or by 4
LOCK	O	Active high phase lock indicator

DLLDELA Delay Block

Closely associated with each DLL is a DLLDELA block. This is a delay block consisting of a delay line with taps and a selection scheme that selects one of the taps. The DCNTL[8:0] bus controls the delay of the CLKO signal. Typically this is the delay setting that the DLL uses to achieve phase alignment. This results in the delay providing a calibrated 90° phase shift that is useful in centering a clock in the middle of a data cycle for source synchronous data. The CLKO signal feeds the edge clock network. Figure 2-7 shows the connections between the DLL block and the DLLDELA delay block. For more information, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-7. DLLDELA Delay Block

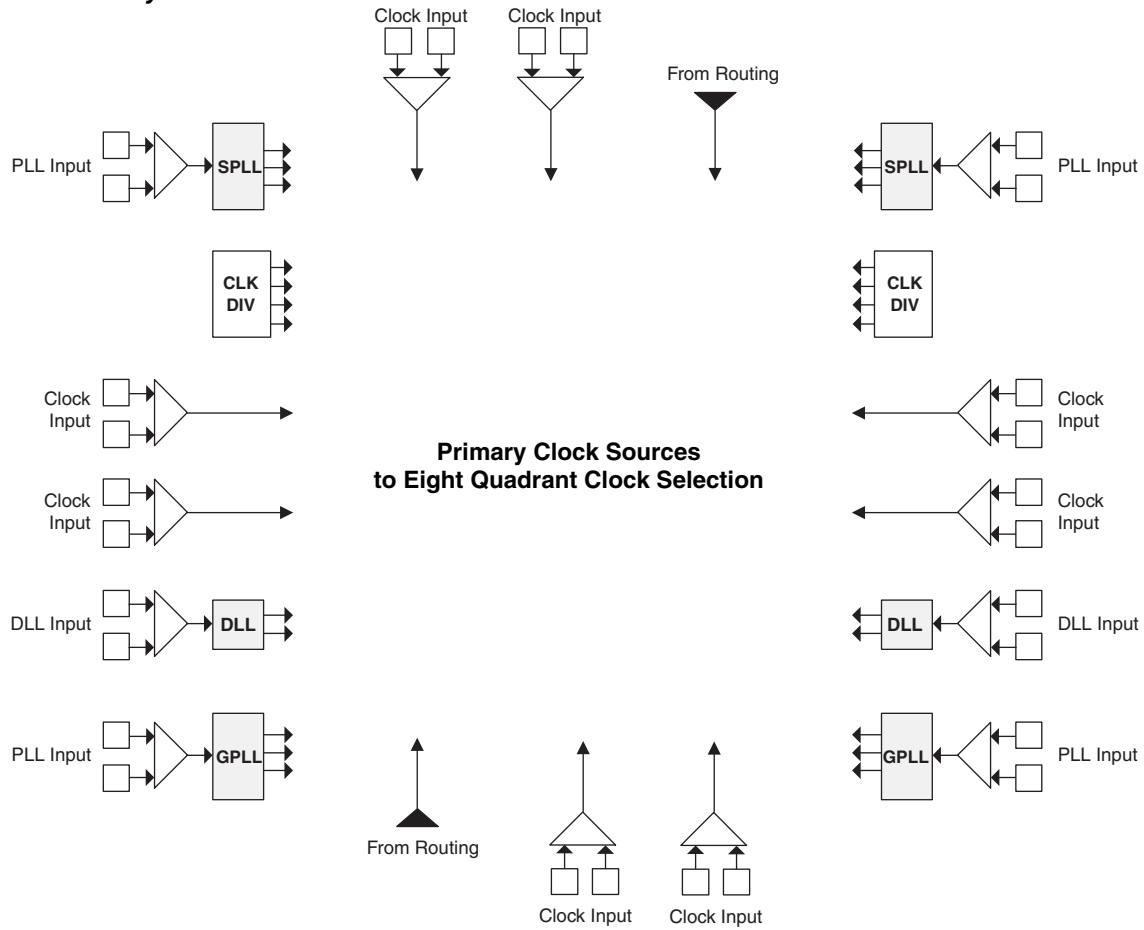


PLL/DLL Cascading

LatticeECP2/M devices have been designed to allow certain combinations of PLL (GPLL and SPLL) and DLL cascading. The allowable combinations are:

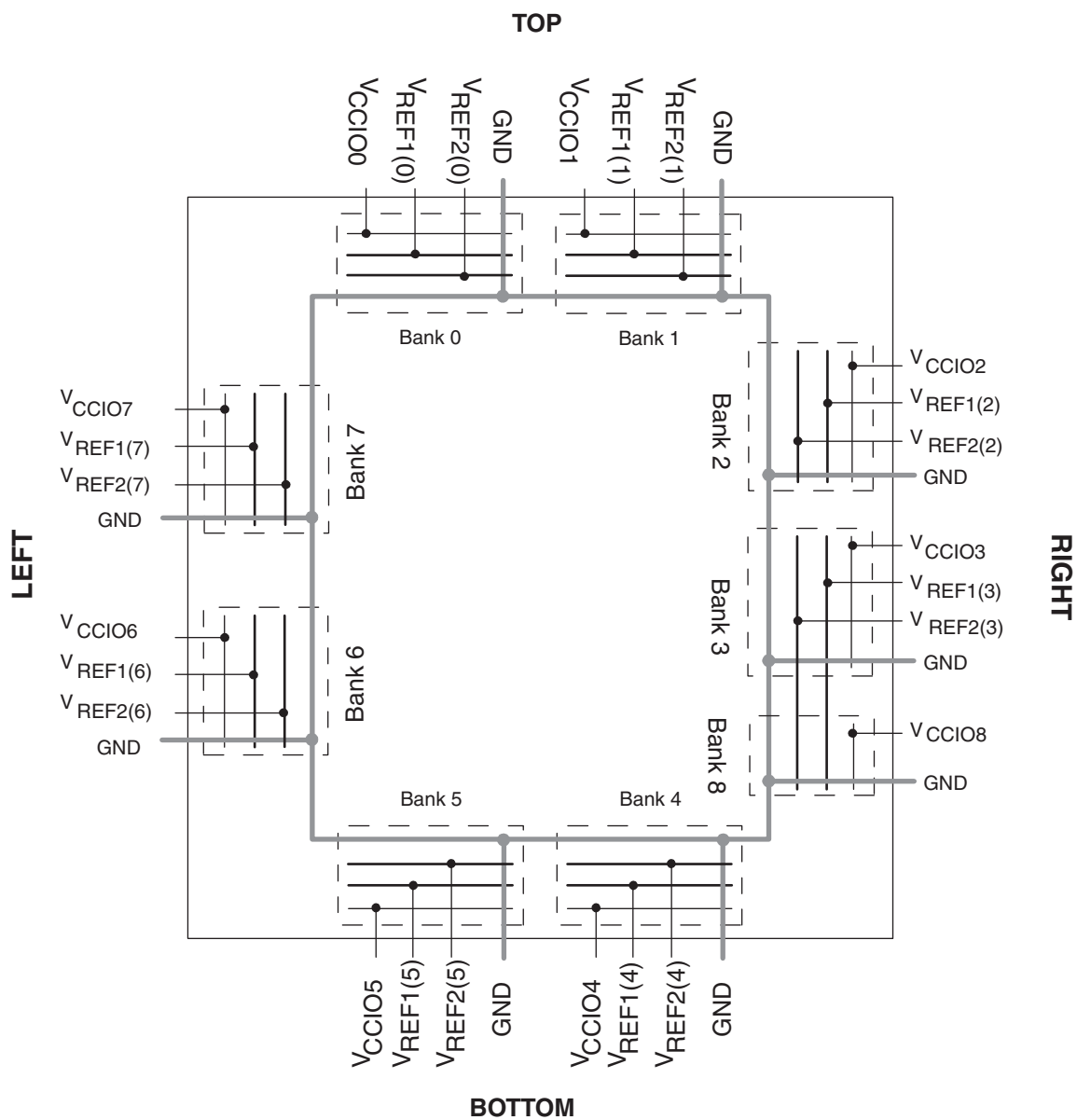
- PLL to PLL supported
- PLL to DLL supported

Figure 2-10. Primary Clock Sources for ECP2-50



Note: This diagram shows sources for the ECP2-50 device. Smaller LatticeECP2 devices have fewer SPLLs. All LatticeECP2M devices have six SPLLs.

Figure 2-37. LatticeECP2 Banks



BLVDS

The LatticeECP2/M devices support the BLVDS standard. This standard is emulated using complementary LVC-MOS outputs in conjunction with a parallel external resistor across the driver outputs. BLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-2 is one possible solution for bi-directional multi-point differential signals.

Figure 3-2. BLVDS Multi-point Output Example

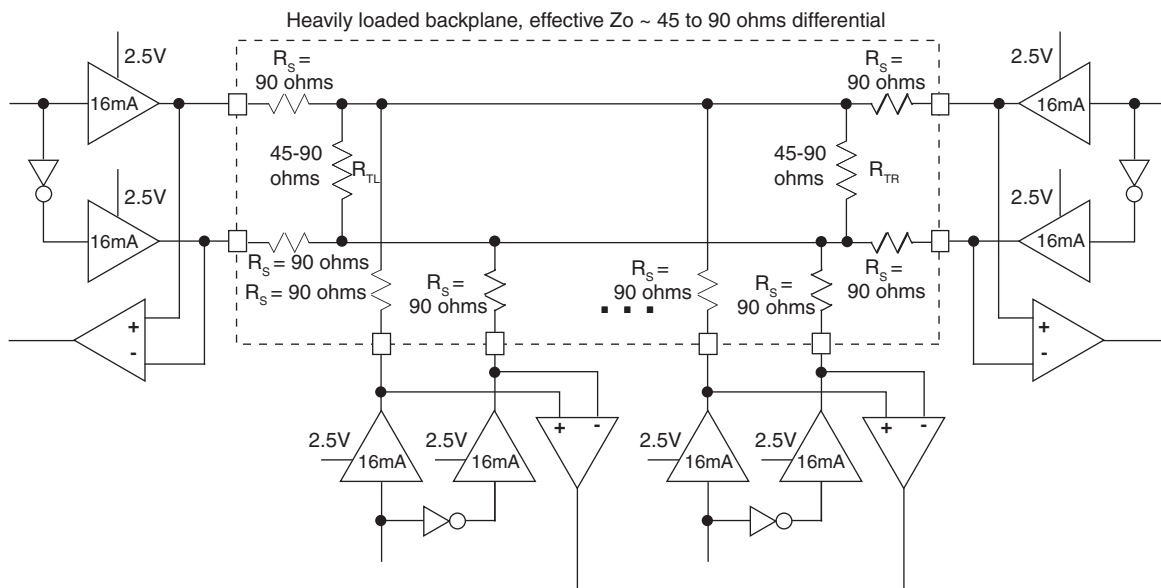


Table 3-3. BLVDS DC Conditions¹

Over Recommended Operating Conditions

Parameter	Description	Typical		Units
		Zo = 45Ω	Zo = 90Ω	
V _{CCIO}	Output Driver Supply (+/- 5%)	2.50	2.50	V
Z _{OUT}	Driver Impedance	10.00	10.00	Ω
R _S	Driver Series Resistor (+/- 1%)	90.00	90.00	Ω
R _{TL}	Driver Parallel Resistor (+/- 1%)	45.00	90.00	Ω
R _{TR}	Receiver Termination (+/- 1%)	45.00	90.00	Ω
V _{OH}	Output High Voltage	1.38	1.48	V
V _{OL}	Output Low Voltage	1.12	1.02	V
V _{OD}	Output Differential Voltage	0.25	0.46	V
V _{CM}	Output Common Mode Voltage	1.25	1.25	V
I _{DC}	DC Output Current	11.24	10.20	mA

1. For input buffer, see LVDS table.

Typical Building Block Function Performance¹

Pin-to-Pin Performance (LVCMOS25 12mA Drive)

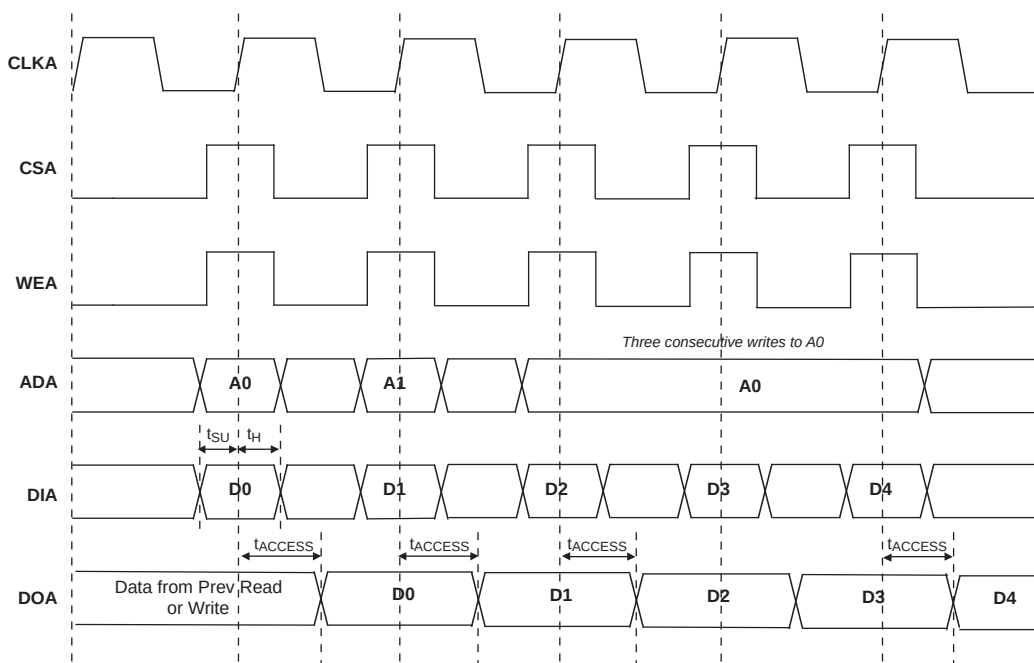
Function	-7 Timing	Units
Basic Functions		
16-bit Decoder	3.8	ns
32-bit Decoder	4.5	ns
64-bit Decoder	5.0	ns
4:1 MUX	3.2	ns
8:1 MUX	3.4	ns
16:1 MUX	3.5	ns
32:1 MUX	4.0	ns

1. These timing numbers were generated using the ispLEVER 8.0 design tool. Exact performance may vary with device and tool version. The tool uses internal parameters that have been characterized but are not tested on every device.

Register-to-Register Performance

Function	-7 Timing	Units
Basic Functions		
16-bit Decoder	599	MHz
32-bit Decoder	542	MHz
64-bit Decoder	417	MHz
4:1 MUX	847	MHz
8:1 MUX	803	MHz
16:1 MUX	660	MHz
32:1 MUX	577	MHz
8-bit Adder	591	MHz
16-bit Adder	500	MHz
64-bit Adder	306	MHz
16-bit Counter	488	MHz
32-bit Counter	378	MHz
64-bit Counter	260	MHz
64-bit Accumulator	253	MHz
Embedded Memory Functions		
512x36 Single Port RAM, EBR Output Registers	370	MHz
1024x18 True-Dual Port RAM (Write Through or Normal, EBR Output Registers)	370	MHz
1024x18 True-Dual Port RAM (Write Through or Normal, PLC Output Registers)	280	MHz
Distributed Memory Functions		
16x4 Pseudo-Dual Port RAM (One PFU)	819	MHz
32x4 Pseudo-Dual Port RAM	521	MHz
64x8 Pseudo-Dual Port RAM	435	MHz
DSP Functions		
18x18 Multiplier (All Registers)	420	MHz
9x9 Multiplier (All Registers)	420	MHz

Figure 3-11. Write Through (SP Read/Write on Port A, Input Registers Only)



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

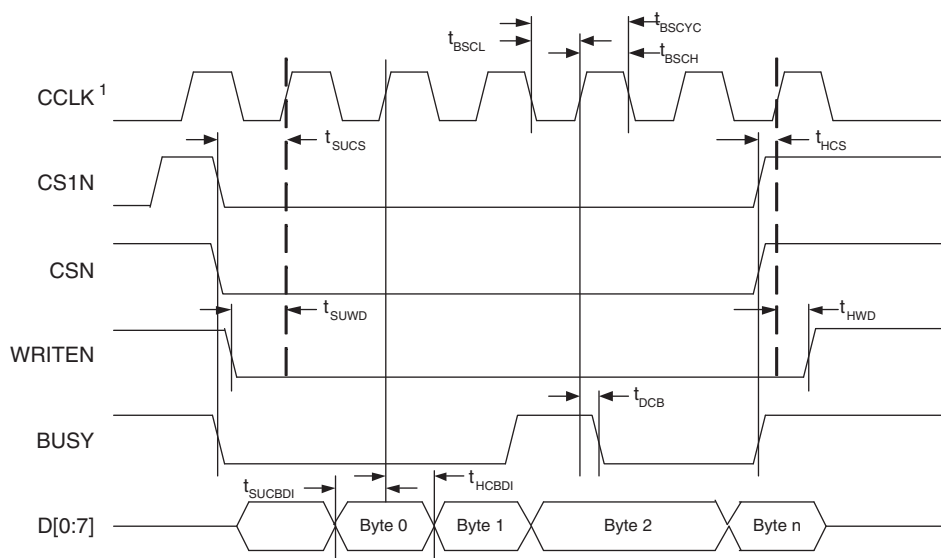
Table 3-13. Periodic Receiver Jitter Tolerance Specification¹

Description	Frequency	Condition	Min.	Typ.	Max.	Units
Periodic	3.125 Gbps	600 mV differential eye	—	—	0.20	UI, p-p
	2.5 Gbps	600 mV differential eye	—	—	0.22	UI, p-p
	1.25 Gbps	600 mV differential eye	—	—	0.20	UI, p-p
	250 Mbps ²	600 mV differential eye	—	—	0.08	UI, p-p

1. Values are measured with PRBS 2⁷-1, all channels operating.

2. Jitter specification is limited by measurement equipment capability.

Figure 3-15. sysCONFIG Parallel Port Write Cycle



1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

Figure 3-16. sysCONFIG Slave Serial Port Timing

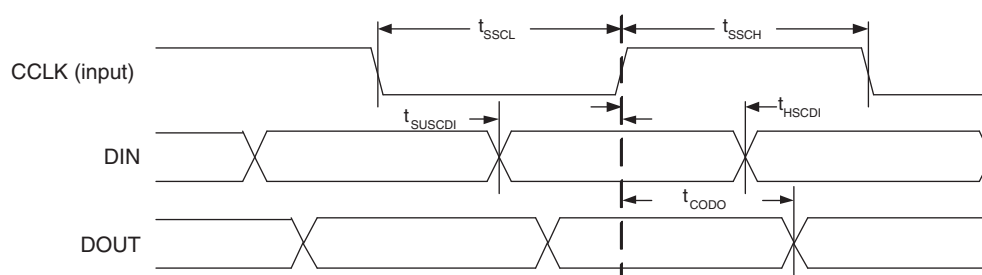
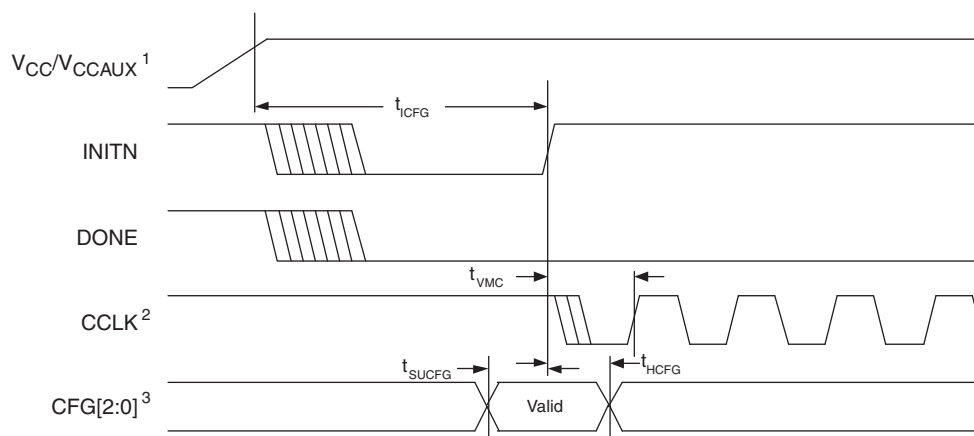


Figure 3-17. Power-On-Reset (POR) Timing



1. Time taken from V_{CC} or V_{CCAUX} , whichever is the last to reach its V_{MIN} .
2. Device is in a Master Mode.
3. The CFG pins are normally static (hard wired).

Signal Descriptions

Signal Name	I/O	Description
General Purpose		
P[Edge] [Row/Column Number*]_[A/B]	I/O	[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top). [Row/Column Number] indicates the PFU row or the column of the device on which the PIC exists. When Edge is T (Top) or B (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number. [A/B] indicates the PIO within the PIC to which the pad is connected. Some of these user-programmable pins are shared with special function pins. These pins, when not used as special purpose pins, can be programmed as I/Os for user logic. During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration. See “Typical sysI/O I/O Behavior During Power-up” for more information about I/O behavior during power-up.
GSRN	I	Global RESET signal (active low). Any I/O pin can be GSRN.
NC	—	No connect.
GND	—	Ground. Dedicated pins.
V _{CC}	—	Power supply pins for core logic. Dedicated pins.
V _{CCAUX}	—	Auxiliary power supply pin. This dedicated pin powers all the differential and referenced input buffers.
V _{CCIOx}	—	Dedicated power supply pins for I/O bank x.
V _{CCPLL}	—	PLL supply pins. Should be tied to V _{CC} even when the corresponding PLL is unused.
V _{REF1_x} , V _{REF2_x}	—	Reference supply pins for I/O bank x. Pre-determined pins in each bank are assigned as V _{REF} inputs. When not used, they may be used as I/O pins.
XRES ⁴	—	10K ohm +/-1% resistor must be connected between this pad and ground.
PLLCAP ⁴	—	External capacitor connection for PLL.
PLL, DLL and Clock Functions (Used as user programmable I/O pins when not in use for PLL or clock pins)		
[LOC][num]_V _{CCPLL}	—	Power supply pin for PLL: LUM, LLM, RUM, RLM, num = row from center.
[LOC][num]_GPLL[T, C]_IN_A	I	General Purpose PLL (GPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_GPLL[T, C]_FB_A	I	Optional feedback GPLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_SPLL[T, C]_IN_A ⁵	I	Secondary PLL (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_SPLL[T, C]_FB_A ⁵	I	Optional feedback (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_DLL[T, C]_IN_A	I	DLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_DLL[T, C]_FB_A	I	Optional feedback (DLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
PCLK[T, C]_[n:0]_[3:0]	I	Primary Clock pads, T = true and C = complement, n per side, indexed by bank and 0,1,2,3 within bank.

LatticeECP2 Pin Information Summary, LFE2-6 and LFE2-12 (Cont.)

Pin Type		LFE2-6		LFE2-12			
		144 TQFP	256 fpBGA	144 TQFP	208 PQFP	256 fpBGA	484 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0
	Bank2	0	1	0	0	1	1
	Bank3	0	0	0	0	0	0
	Bank4	0	2	0	0	2	3
	Bank5	0	1	0	0	1	3
	Bank6	0	1	0	0	1	1
	Bank7	0	1	0	0	1	1
	Bank8	0	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0
	Bank2	0	0	0	0	0	0
	Bank3	0	0	0	0	0	0
	Bank4	18	32	18	19	32	46
	Bank5	8	14	10	18	17	46
	Bank6	0	0	0	0	0	0
	Bank7	0	0	0	0	0	0
	Bank8	0	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
136	PT6B	0		C	PT16B	0		C
137	PT6A	0		T	PT16A	0		T
138	GND	-			GND	-		
139	VCCIO0	0			VCCIO0	0		
140	PT4B	0		C	PT6B	0		C
141	PT4A	0		T	PT6A	0		T
142	VCCAUX	-			VCCAUX	-		
143	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C
144	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one-to-one connection with a package ball or pin.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
1	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*	
2	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*	
3	PL4A	7		T (LVDS)*	PL6A	7	LDQ8	T (LVDS)*	
4	PL4B	7		C (LVDS)*	PL6B	7	LDQ8	C (LVDS)*	
5	GND	-			GND	-			
6	PL6A	7	LDQ10	T (LVDS)*	PL12A	7	LDQ16	T (LVDS)*	
7	VCCAUX	-			VCCAUX	-			
8	PL6B	7	LDQ10	C (LVDS)*	PL12B	7	LDQ16	C (LVDS)*	
9	PL8A	7	LDQ10	T (LVDS)*	PL14A	7	LDQ16	T (LVDS)*	
10	VCCIO7	7			VCCIO7	7			
11	PL8B	7	LDQ10	C (LVDS)*	PL14B	7	LDQ16	C (LVDS)*	
12	VCC	-			VCC	-			
13	GND	-			GND	-			
14	VCCIO7	7			VCCIO7	7			
15	PL12A	7	LDQ10	T (LVDS)*	PL18A	7	LDQ16	T (LVDS)*	
16	PL12B	7	LDQ10	C (LVDS)*	PL18B	7	LDQ16	C (LVDS)*	
17	GND	-			GND	-			
18	PL13A	7	PCLKT7_0/LDQ10	T	PL19A	7	PCLKT7_0/LDQ16	T	
19	VCC	-			VCC	-			
20	PL13B	7	PCLKC7_0/LDQ10	C	PL19B	7	PCLKC7_0/LDQ16	C	
21	PL15A	6	PCLKT6_0	T (LVDS)*	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*	
22	PL15B	6	PCLKC6_0	C (LVDS)*	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*	
23	PL16A	6	VREF2_6	T	PL22A	6	VREF2_6/LDQ25	T	
24	PL16B	6	VREF1_6	C	PL22B	6	VREF1_6/LDQ25	C	
25	GND	-			GND	-			
26	PL17A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*	
27	PL17B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*	
28	VCC	-			VCC	-			
29	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
30	VCCAUX	-			VCCAUX	-			
31	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*	
32	GND	-			GND	-			
33	PL21A	6	LLM0_GPLLT_FB_A	T	PL31A	6	LLM0_GPLLT_FB_A/LDQ34	T	
34	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL30B	6	LLM0_GPLLC_IN_A**/LDQ34	C (LVDS)*	
35	PL21B	6	LLM0_GPLLC_FB_A	C	PL31B	6	LLM0_GPLLC_FB_A/LDQ34	C	
36	PL23A	6			PL33A	6	LDQ34		
37	PL24A	6	LDQ28	T (LVDS)*	PL38A	6	LDQ42	T (LVDS)*	
38	VCCIO6	6			VCCIO6	6			
39	PL24B	6	LDQ28	C (LVDS)*	PL38B	6	LDQ42	C (LVDS)*	
40	VCC	-			VCC	-			
41	PL26A	6	LDQ28	T (LVDS)*	PL40A	6	LDQ42	T (LVDS)*	
42	GND	-			GND	-			
43	PL26B	6	LDQ28	C (LVDS)*	PL40B	6	LDQ42	C (LVDS)*	
44	VCCIO6	6			VCCIO6	6			
45	PL28A	6	LDQS28	T (LVDS)*	PL42A	6	LDQS42	T (LVDS)*	

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO6	-			GNDIO6	-		
L2	PL24A	6	LDQ28	T (LVDS)*	PL24A	6	LDQ28	T (LVDS)*
K2	PL25A	6	LDQ28	T	PL25A	6	LDQ28	T
L3	PL24B	6	LDQ28	C (LVDS)*	PL24B	6	LDQ28	C (LVDS)*
K1	PL25B	6	LDQ28	C	PL25B	6	LDQ28	C
VCCIO	VCCIO6	6			VCCIO6	6		
L4	PL26A	6	LDQ28	T (LVDS)*	PL26A	6	LDQ28	T (LVDS)*
L1	PL27A	6	LDQ28	T	PL27A	6	LDQ28	T
L5	PL26B	6	LDQ28	C (LVDS)*	PL26B	6	LDQ28	C (LVDS)*
M1	PL27B	6	LDQ28	C	PL27B	6	LDQ28	C
GND	GNDIO6	-			GNDIO6	-		
N1	PL29A	6	LDQ28	T	PL29A	6	LDQ28	T
N2	PL28A	6	LDQS28	T (LVDS)*	PL28A	6	LDQS28	T (LVDS)*
P1	PL29B	6	LDQ28	C	PL29B	6	LDQ28	C
VCCIO	VCCIO6	6			VCCIO6	6		
P2	PL28B	6	LDQ28	C (LVDS)*	PL28B	6	LDQ28	C (LVDS)*
R1	PL30A	6	LDQ28	T (LVDS)*	PL30A	6	LDQ28	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
R2	PL30B	6	LDQ28	C (LVDS)*	PL30B	6	LDQ28	C (LVDS)*
N4	TDI	-			TDI	-		
M4	TCK	-			TCK	-		
P3	TDO	-			TDO	-		
N3	TMS	-			TMS	-		
K7	VCCJ	-			VCCJ	-		
M5	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
K6	NC	-			PB3A	5	BDQ6	
M6	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
R3	NC	-			PB5A	5	BDQ6	T
P4	NC	-			PB5B	5	BDQ6	C
-	-	-			VCCIO	5		
-	-	-			GNDIO5	5		
N5	PB3A	5	BDQ6	T	PB21A	5	BDQ24	T
N6	PB3B	5	BDQ6	C	PB21B	5	BDQ24	C
T2	PB4A	5	BDQ6	T	PB22A	5	BDQ24	T
P6	PB5A	5	BDQ6	T	PB23A	5	BDQ24	T
VCCIO	VCCIO5	5			VCCIO5	5		
T3	PB4B	5	BDQ6	C	PB22B	5	BDQ24	C
R6	PB5B	5	BDQ6	C	PB23B	5	BDQ24	C
GND	GNDIO5	-			GNDIO5	-		
R4	PB6A	5	BDQS6	T	PB24A	5	BDQS24	T
L6	PB7A	5	BDQ6	T	PB25A	5	BDQ24	T
T4	PB6B	5	BDQ6	C	PB24B	5	BDQ24	C
L7	PB7B	5	BDQ6	C	PB25B	5	BDQ24	C
N7	PB8A	5	PCLKT5_0/BDQ6	T	PB26A	5	PCLKT5_0/BDQ24	T
VCCIO	VCCIO5	5			VCCIO5	5		

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
G24	PR14B	2	RDQ16	C (LVDS)*	PR27B	2	RDQ29	C (LVDS)*	
G23	PR14A	2	RDQ16	T (LVDS)*	PR27A	2	RDQ29	T (LVDS)*	
VCCIO	VCCIO2	2			VCCIO2	2			
K19	PR13B	2	RDQ16	C	PR26B	2	RDQ29	C	
J19	PR13A	2	RDQ16	T	PR26A	2	RDQ29	T	
D26	PR12B	2	RDQ16	C (LVDS)*	PR25B	2	RDQ29	C (LVDS)*	
C26	PR12A	2	RDQ16	T (LVDS)*	PR25A	2	RDQ29	T (LVDS)*	
F22	PR11B	2	RDQ8	C	PR24B	2	RDQ21	C	
E24	PR11A	2	RDQ8	T	PR24A	2	RDQ21	T	
GND	GNDIO2	-			GNDIO2	-			
D25	PR10B	2	RDQ8	C (LVDS)*	PR23B	2	RDQ21	C (LVDS)*	
C25	PR10A	2	RDQ8	T (LVDS)*	PR23A	2	RDQ21	T (LVDS)*	
D24	PR9B	2	RDQ8	C	PR22B	2	RDQ21	C	
B25	PR9A	2	RDQ8	T	PR22A	2	RDQ21	T	
VCCIO	VCCIO2	2			VCCIO2	2			
H21	PR8B	2	RDQ8	C (LVDS)*	PR21B	2	RDQ21	C (LVDS)*	
G22	PR8A	2	RDQS8	T (LVDS)*	PR21A	2	RDQS21	T (LVDS)*	
B24	PR7B	2	RDQ8	C	PR20B	2	RDQ21	C	
GND	GNDIO2	-			GNDIO2	-			
C24	PR7A	2	RDQ8	T	PR20A	2	RDQ21	T	
D23	PR6B	2	RDQ8	C (LVDS)*	PR19B	2	RDQ21	C (LVDS)*	
C23	PR6A	2	RDQ8	T (LVDS)*	PR19A	2	RDQ21	T (LVDS)*	
G21	PR5B	2	RDQ8	C	PR18B	2	RDQ21	C	
VCCIO	VCCIO2	2			VCCIO2	2			
H20	PR5A	2	RDQ8	T	PR18A	2	RDQ21	T	
GND	GNDIO2	-			GNDIO2	-			
E22	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*	
F21	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*	
E23	PT82B	1	VREF2_1	C	PT100B	1	VREF2_1	C	
GND	GNDIO1	-			GNDIO1	-			
D22	PT82A	1	VREF1_1	T	PT100A	1	VREF1_1	T	
G20	PT81B	1		C	PT99B	1		C	
J18	PT81A	1		T	PT99A	1		T	
F20	PT80B	1		C	PT98B	1		C	
VCCIO	VCCIO1	1			VCCIO1	1			
H19	PT80A	1		T	PT98A	1		T	
A24	PT79B	1		C	PT97B	1		C	
A23	PT79A	1		T	PT97A	1		T	
E21	PT78B	1		C	PT96B	1		C	
F19	PT78A	1		T	PT96A	1		T	
C22	PT77B	1		C	PT95B	1		C	
GND	GNDIO1	-			GNDIO1	-			
E20	PT77A	1		T	PT95A	1		T	
B22	PT76B	1		C	PT94B	1		C	
VCCIO	VCCIO1	1			VCCIO1	1			
B23	PT76A	1		T	PT94A	1		T	

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
A12	PT35B	0		C	PT44B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
A11	PT35A	0		T	PT44A	0		T	
D12	PT34B	0		C	PT43B	0		C	
H16	PT34A	0		T	PT43A	0		T	
H18	PT33B	0		C	PT42B	0		C	
H15	PT33A	0		T	PT42A	0		T	
A10	PT32B	0		C	PT41B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			
B10	PT32A	0		T	PT41A	0		T	
D11	PT31B	0		C	PT40B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
G14	PT31A	0		T	PT40A	0		T	
E11	PT30B	0		C	PT39B	0		C	
F13	PT30A	0		T	PT39A	0		T	
D10	PT29B	0		C	PT38B	0		C	
H14	PT29A	0		T	PT38A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
VCCIO	VCCIO0	0			VCCIO0	0			
A9	PT24B	0		C	PT24B	0		C	
C10	PT23B	0		C	PT23B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			
E8	PT23A	0		T	PT23A	0		T	
B9	PT22B	0		C	PT22B	0		C	
A8	PT22A	0		T	PT22A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
F12	PT21B	0		C	PT21B	0		C	
E10	PT21A	0		T	PT21A	0		T	
G13	PT20B	0		C	PT20B	0		C	
C9	PT20A	0		T	PT20A	0		T	
B8	PT19B	0		C	PT19B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			
A7	PT19A	0		T	PT19A	0		T	
D9	PT18B	0		C	PT18B	0		C	
H13	PT18A	0		T	PT18A	0		T	
D6	PT17B	0		C	PT17B	0		C	
C7	PT17A	0		T	PT17A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
C8	PT16B	0		C	PT16B	0		C	
G12	PT16A	0		T	PT16A	0		T	
D8	PT15B	0		C	PT15B	0		C	
H12	PT15A	0		T	PT15A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
A6	PT14B	0		C	PT14B	0		C	
A5	PT14A	0		T	PT14A	0		T	
A4	PT13B	0		C	PT13B	0		C	
A3	PT13A	0		T	PT13A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AG2	PB34A	5	BDQ33	T
AG3	PB34B	5	BDQ33	C
AD13	PB35A	5	BDQ33	T
VCCIO	VCCIO5	5		
AC13	PB35B	5	BDQ33	C
AE14	PB36A	5	BDQ33	T
AC14	PB36B	5	BDQ33	C
AF3	PB37A	5	BDQ33	T
GNDIO	GNDIO5	-		
AF4	PB37B	5	BDQ33	C
-	-	-		
AG4	PB38A	5	BDQ42	T
AG5	PB38B	5	BDQ42	C
GNDIO	GNDIO5	-		
-	-	-		
AD11	PB48A	5	BDQ51	T
AF13	PB48B	5	BDQ51	C
AF12	PB49A	5	BDQ51	T
VCCIO	VCCIO5	5		
AD14	PB49B	5	BDQ51	C
AG8	PB50A	5	BDQ51	T
AF8	PB50B	5	BDQ51	C
AE15	PB51A	5	BDQS51****	T
GNDIO	GNDIO5	-		
-	-	-		
AC15	PB51B	5	BDQ51	C
VCCIO	VCCIO5	5		
GNDIO	GNDIO5	-		
AD15	PB56A	5	BDQ60	T
AF15	PB56B	5	BDQ60	C
AG10	PB57A	5	BDQ60	T
AG9	PB57B	5	BDQ60	C
AH14	PB58A	5	BDQ60	T
AG12	PB58B	5	BDQ60	C
VCCIO	VCCIO5	5		
AG15	PB59A	5	BDQ60	T
AG13	PB59B	5	BDQ60	C
GNDIO	GNDIO5	-		
AF16	PB60A	5	BDQS60	T
AH15	PB60B	5	BDQ60	C
AC16	PB61A	5	VREF2_5/BDQ60	T
AE16	PB61B	5	VREF1_5/BDQ60	C
AG11	PB62A	5	PCLKT5_0/BDQ60	T

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U22	GND	-			GND	-		
U23	GND	-			GND	-		
V12	GND	-			GND	-		
V13	GND	-			GND	-		
V15	GND	-			GND	-		
V16	GND	-			GND	-		
V17	GND	-			GND	-		
V18	GND	-			GND	-		
V19	GND	-			GND	-		
V20	GND	-			GND	-		
V22	GND	-			GND	-		
V23	GND	-			GND	-		
W12	GND	-			GND	-		
W13	GND	-			GND	-		
W15	GND	-			GND	-		
W16	GND	-			GND	-		
W17	GND	-			GND	-		
W18	GND	-			GND	-		
W19	GND	-			GND	-		
W20	GND	-			GND	-		
W22	GND	-			GND	-		
W23	GND	-			GND	-		
W26	GND	-			GND	-		
W31	GND	-			GND	-		
W4	GND	-			GND	-		
W9	GND	-			GND	-		
Y16	GND	-			GND	-		
Y17	GND	-			GND	-		
Y18	GND	-			GND	-		
Y19	GND	-			GND	-		
A11	NC	-			NC	-		
A12	NC	-			NC	-		
A23	NC	-			NC	-		
A24	NC	-			NC	-		
AA11	NC	-			NC	-		
AB11	NC	-			NC	-		
AC26	NC	-			NC	-		
AC30	NC	-			NC	-		
AD11	NC	-			NC	-		
AD12	NC	-			NC	-		
AD13	NC	-			NC	-		
AD14	NC	-			NC	-		
AD15	NC	-			NC	-		
AD19	NC	-			NC	-		
AD21	NC	-			NC	-		
AD22	NC	-			NC	-		
AD23	NC	-			NC	-		
AE10	NC	-			NC	-		
AE11	NC	-			NC	-		

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100SE-5FN1152C	520	1.2V	-5	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-6FN1152C	520	1.2V	-6	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-7FN1152C	520	1.2V	-7	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	Com	100
LFE2M100SE-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	Com	100
LFE2M100SE-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	Com	100